

1W AUDIO AMPLIFIER WITH MUTE

1 FEATURES

- OPERATING VOLTAGE 1.8 TO 15 V
- EXTERNAL MUTE OR POWER DOWN FUNCTION
- IMPROVED SUPPLY VOLTAGE REJECTION
- LOW QUIESCENT CURRENT
- HIGH POWER CAPABILITY
- LOW CROSSOVER DISTORTION

2 DESCRIPTION

The TDA7233/D is a monolithic integrated circuit in 8 pin Minidip or SO8 package, intended for use as class AB power amplifier with a wide range of supply voltage from 1.8V to 15V in portable players, cordless telephones and Cellular Radios.

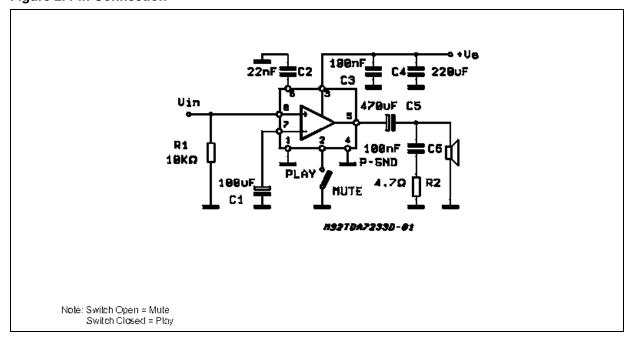
Figure 1. Package



Table 1. Order Codes

| Part Number | Package |
|-------------|---------|
| TDA7233 | Minidip |
| TDA7233D | SO8 |

Figure 2. Pin Connection



May 2010 1/8

Table 2. Absolute Maximum Ratings

| Symbol | Parameter | Value | Unit |
|-----------------------------------|---|------------|------|
| Vs | Supply Voltage | 16 | V |
| P _{tot} | Total Power Dissipation at T _{amb} = 50 °C | 1 | W |
| I ₀ | Output Peak Current | 1 | Α |
| T _{stg} , T _j | Storage and Junction Temperature | -40 to 150 | °C |

Figure 3. PIN CONNECTIONS (top view)

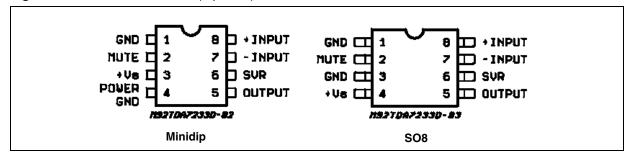


Table 3. Thermal Data

| Symbol | Parameter | S08 | MInidip | Unit | |
|-----------------------|-------------------------------------|------|---------|------|------|
| R _{th j-amb} | Thermal Resistance Junction-ambient | Max. | 200 | 100 | °C/W |

Table 4. Electrical Characteristcs (V_s = 6 V, T_{amb} = 25 °C, unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Unit |
|-----------------|--------------------------|---|------|--|------|------------------------------|
| Vs | Supply Voltage | | 1.8 | | 15 | V |
| Vo | Quiescent Output Voltage | Vs = 3 V Vs = 9 V | | 2.7 1.2 4.2 | | V |
| I _d | Quiescent Drain Current | MUTE HIGH | | 3.6 | 9 | mA |
| | | MUTE LOW | | 0.4 | | mA |
| I _b | Input Bias Current | | | 100 | | nA |
| Po | Output Power | $\begin{array}{l} d = 10\%; f = 1 \text{kHz} \\ \text{Vs} = 12 \text{V}; R_L = 8 \Omega \\ \text{Vs} = 9 \text{V}; R_L = 4 \Omega \\ \text{Vs} = 9 \text{V}; R_L = 8 \Omega \\ \text{Vs} = 6 \text{V}; R_L = 8 \Omega \\ \text{Vs} = 6 \text{V}; R_L = 4 \Omega \\ \text{Vs} = 3 \text{V}; R_L = 4 \Omega \\ \text{Vs} = 3 \text{V}; R_L = 8 \Omega \\ \end{array}$ | | 1.9 1.6 1 0.4 0.7 110 70 | | W W W W mW mW |
| d | Distortion | Po = 0.5W; f = 1KHz; $R_L = 8\Omega$ Vs = 9V | | 0.3 | | % |
| Gv | Closed Loop Voltage Gain | f = 1KHz; | | 39 | | dB |
| R _{in} | Input Resistance | f = 1KHz; | 100 | | | KΩ |
| e _N | Total Input Noise | Rs = $10K\Omega$; B = Curve A Rs = $10K\Omega$; B = $22Hz$ to $22KHz$ | | 2 3 | | μV μV |
| SVR | Supply Voltage Rejection | $f = 100Hz; R_g = 10K\Omega$ | | 45 | | dB |
| | MUTE Attenuation | Vo = 1V; f = 100Hz to 10KHz; | | 70 | | dB |
| | MUTE Threshold | | | 0.6 | | V |
| IM | MUTE Current | Vs = 15V | | 0.4 | | mA |

4

Figure 4. Output Power versus Supply Voltage

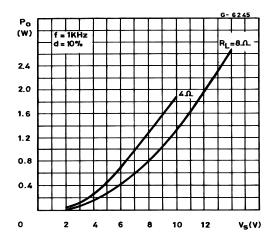


Figure 5. Supply Voltage Rejection versus Frequency

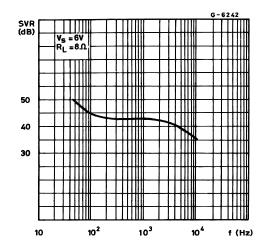


Figure 6. DC Output Voltage versus Supply Voltage

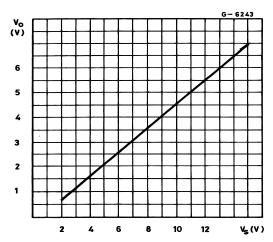


Figure 7. Quiescent Current versus Supply Voltage

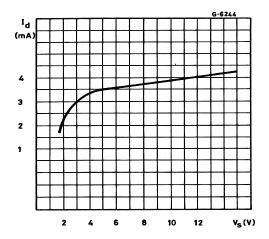
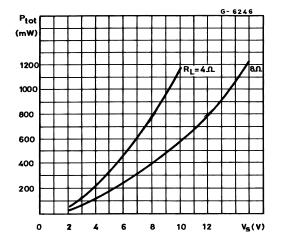


Figure 8. Total Power Dissipated versus Supply Voltage



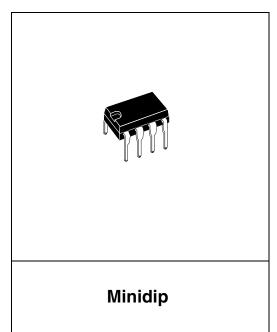
3 PACKAGE MECHANICAL DATA

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Figure 9. Minidip Mechanical Data & Package Dimensions

| DIM. | mm | | | | | |
|------|-------|------|-------|-------|-------|-------|
| DIN. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| Α | | 3.32 | | | 0.131 | |
| a1 | 0.51 | | | 0.020 | | |
| В | 1.15 | | 1.65 | 0.045 | | 0.065 |
| b | 0.356 | | 0.55 | 0.014 | | 0.022 |
| b1 | 0.204 | | 0.304 | 0.008 | | 0.012 |
| D | | | 10.92 | | | 0.430 |
| E | 7.95 | | 9.75 | 0.313 | | 0.384 |
| е | | 2.54 | | | 0.100 | |
| e3 | | 7.62 | | | 0.300 | |
| e4 | | 7.62 | | | 0.300 | |
| F | | | 6.6 | | | 0.260 |
| I | | | 5.08 | | | 0.200 |
| L | 3.18 | | 3.81 | 0.125 | | 0.150 |
| Z | | | 1.52 | | | 0.060 |

OUTLINE AND MECHANICAL DATA



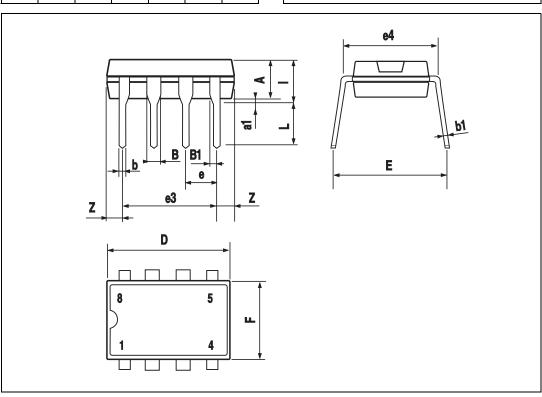


Figure 10. SO8 Mechanical Data & Package Dimensions

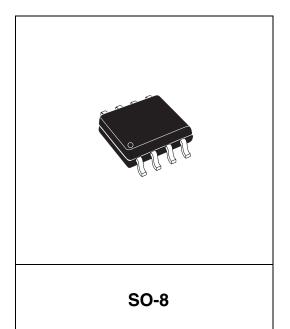
| DIM | DIM. mm | | | inch | | | |
|-------------------|---------|-------|-------|--------|--------|--------|--|
| Dilvi. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | |
| Α | | | 1.750 | | | 0.0689 | |
| A1 | 0.100 | | 0.250 | 0.0039 | | 0.0098 | |
| A2 | 1.250 | | | 0.0492 | | | |
| b | 0.280 | | 0.480 | 0.0110 | | 0.0189 | |
| С | 0.170 | | 0.230 | 0.0067 | | 0.0091 | |
| D ⁽¹⁾ | 4.800 | 4.900 | 5.000 | 0.1890 | 0.1929 | 0.1969 | |
| Е | 5.800 | 6.000 | 6.200 | 0.2283 | 0.2362 | 0.2441 | |
| E1 ⁽²⁾ | 3.800 | 3.900 | 4.000 | 0.1496 | 0.1535 | 0.1575 | |
| е | | 1.270 | | | 0.0500 | | |
| h | 0.250 | | 0.500 | 0.0098 | | 0.0197 | |
| L | 0.400 | | 1.270 | 0.0157 | | 0.0500 | |
| L1 | | 1.040 | | | 0.0409 | | |
| k | 0° | | 8° | 0° | | 8° | |
| ccc | | | 0.100 | | | 0.0039 | |

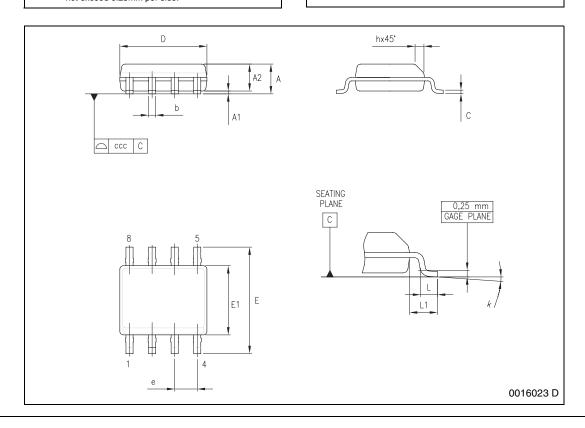
Notes: 1. Dimensions D does not include mold flash, protrusions or gate burrs.

Mold flash, potrusions or gate burrs shall not exceed 0.15mm in total (both side).

2. Dimension "E1" does not include interlead flash

OUTLINE AND MECHANICAL DATA





4

Dimension "E1" does not include interlead flash or protrusions. Interlead flash or protrusions shall not exceed 0.25mm per side.

4 REVISION HISTORY

Table 5. Revision History

| Date | Revision | Description of Changes |
|----------------|----------|--|
| September 2003 | 3 | No recorded changes |
| 03-May-2010 | 4 | Updated title and added environmental compliance statement for package |



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47/